

V_{SM}	=	6500 V
$I_{T(AV)M}$	=	1405 A
$I_{T(RMS)}$	=	2205 A
I_{TSM}	=	22×10^3 A
V_{T0}	=	1.2 V
r_T	=	0.6 mW

Bi-Directional Control Thyristor

5STB 13N6500

Doc. No. 5SYA1035-03 May 06

- Two thyristors integrated into one wafer
- Patented free-floating silicon technology
- Designed for energy management and industrial applications
- Optimum power handling capability
- Interdigitated amplifying gate.

The electrical and thermal data are valid for one-thyristor-half of the device (unless otherwise stated)

Blocking

Maximum rated values ^{Note 1}

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. surge peak blocking voltage	$V_{SM}^{1)}$	$f = 5 \text{ Hz}, t_p = 10 \text{ ms}$			6500	V
Max. repetitive peak reverse blocking voltage	$V_{RM}^{1)}$	$f = 50 \text{ Hz}, t_p = 10 \text{ ms}$			5600	V
Critical rate of rise of commutating voltage	dv/dt_{crit}	Exp. to 3750 V, $T_{vj} = 125^\circ\text{C}$			2000	V/ μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Max. leakage current	I_{RM}	$V_{RM}, T_{vj} = 125^\circ\text{C}$			400	mA

1) V_{RM} is equal to V_{SM} up to $T_{vj} = 110^\circ\text{C}$; de-rating of 0.11% per $^\circ\text{C}$ applicable for T_j below $+5^\circ\text{C}$

Mechanical data

Maximum rated values ^{Note 1}

Parameter	Symbol	Conditions	min	typ	max	Unit
Mounting force	F_M		81	90	108	kN
Acceleration	a	Device unclamped			50	m/s^2
Acceleration	a	Device clamped			100	m/s^2

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Weight	m				2.9	kg
Housing thickness	H	$F_M = 90 \text{ kN}, T_a = 25^\circ\text{C}$	35		35.6	mm
Surface creepage distance	D_S		53			mm
Air strike distance	D_a		22			mm

Note 1 Maximum rated values indicate limits beyond which damage to the device may occur

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



On-state

Maximum rated values ^{Note 1}

Parameter	Symbol	Conditions	min	typ	max	Unit
Average on-state current	$I_{T(AV)M}$	Half sine wave, $T_c = 70\text{ °C}$			1405	A
RMS on-state current	$I_{T(RMS)}$				2205	A
RMS on-state current	$I_{T(RMS)}$	Full sine wave, $T_c = 70\text{ °C}$			3120	A
Peak non-repetitive surge current	I_{TSM}	$t_p = 10\text{ ms}$, $T_{vj} = 125\text{ °C}$, sine wave after surge:			22.0×10^3	A
Limiting load integral	I^2t	$V_D = V_R = 0\text{ V}$			2.42×10^6	A ² s
Peak non-repetitive surge current	I_{TSM}	$t_p = 8.3\text{ ms}$, $T_{vj} = 125\text{ °C}$, sine wave after surge:			24.0×10^3	A
Limiting load integral	I^2t	$V_D = V_R = 0\text{ V}$			2.39×10^6	A ² s

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
On-state voltage	V_T	$I_T = 1500\text{ A}$, $T_{vj} = 125\text{ °C}$			2.12	V
Threshold voltage	V_{T0}	$I_T = 670\text{ A} - 2000\text{ A}$, $T_{vj} = 125\text{ °C}$			1.2	V
Slope resistance	r_T				0.6	mΩ
Holding current	I_H	$T_{vj} = 25\text{ °C}$			300	mA
		$T_{vj} = 125\text{ °C}$			175	mA
Latching current	I_L	$T_{vj} = 25\text{ °C}$			500	mA
		$T_{vj} = 125\text{ °C}$			300	mA

Switching

Maximum rated values ^{Note 1}

Parameter	Symbol	Conditions	min	typ	max	Unit
Critical rate of rise of on-state current	di/dt_{crit}	$T_{vj} = 125\text{ °C}$, Cont. $I_{TRM} = 2000\text{ A}$, $f = 50\text{ Hz}$			250	A/μs
Critical rate of rise of on-state current	di/dt_{crit}	$V_D \leq 3750\text{ V}$, Cont. $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ μs}$, $f = 1\text{ Hz}$			500	A/μs
Circuit commutated turn-off time	t_q	$T_{vj} = 125\text{ °C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1.5\text{ A/μs}$, $V_D \leq 0.67 \cdot V_{RM}$, $dv_D/dt = 20\text{ V/μs}$,	800			μs

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Recovery charge	Q_{rr}	$T_{vj} = 125\text{ °C}$, $I_{TRM} = 2000\text{ A}$, $V_R = 200\text{ V}$, $di_T/dt = -1.5\text{ A/μs}$	2400		3800	μAs
Recovery charge	I_{RM}		50		70	A
Gate turn-on delay time	t_{gd}	$T_{vj} = 25\text{ °C}$, $V_D = 0.4 \cdot V_{RM}$, $I_{FG} = 2\text{ A}$, $t_r = 0.5\text{ μs}$			3	μs

Triggering

Maximum rated values ^{Note 1}

Parameter	Symbol	Conditions	min	typ	max	Unit
Peak forward gate voltage	V_{FGM}				12	V
Max. rated peak forward gate current	I_{FGM}				10	A
Peak reverse gate voltage	V_{RGM}				10	V
Max. rated gate power loss	P_G	For DC gate current			3	W
Max. rated peak forward gate power	P_{GM}		see Fig. 9			

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Gate trigger voltage	V_{GT}	$T_{vj} = 25\text{ °C}$			2.6	V
Gate trigger current	I_{GT}	$T_{vj} = 25\text{ °C}$			400	mA
Gate non-trigger voltage	V_{GD}	$V_D = 0.4 \times V_{RM}$, $T_{vj} = 125\text{ °C}$	0.3			V
Gate non-trigger current	I_{GD}	$V_D = 0.4 \times V_{RM}$	10			mA

Thermal

Maximum rated values ^{Note 1}

Parameter	Symbol	Conditions	min	typ	max	Unit
Operating junction temperature range	T_{vj}				125	°C
Storage temperature range	T_{stg}		-40		140	°C

Characteristic values

Parameter	Symbol	Conditions	min	typ	max	Unit
Thermal resistance junction to case (Valid for one thyristor half no heat flow to the second half.)	$R_{th(j-c)}$	Double-side cooled $F_m = 81...108\text{ kN}$			11.4	K/kW
	$R_{th(j-c)A}$	Anode-side cooled $F_m = 81...108\text{ kN}$			22.8	K/kW
	$R_{th(j-c)C}$	Cathode-side cooled $F_m = 81...108\text{ kN}$			22.8	K/kW
Thermal resistance case to heatsink	$R_{th(c-h)}$	Double-side cooled $F_m = 81...108\text{ kN}$			2	K/kW
	$R_{th(c-h)}$	Single-side cooled $F_m = 81...108\text{ kN}$			4	K/kW

Analytical function for transient thermal impedance:

$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i (1 - e^{-t/\tau_i})$$

i	1	2	3	4
R_i (K/kW)	6.770	2.510	1.340	0.780
τ_i (s)	0.8651	0.1558	0.0212	0.0075

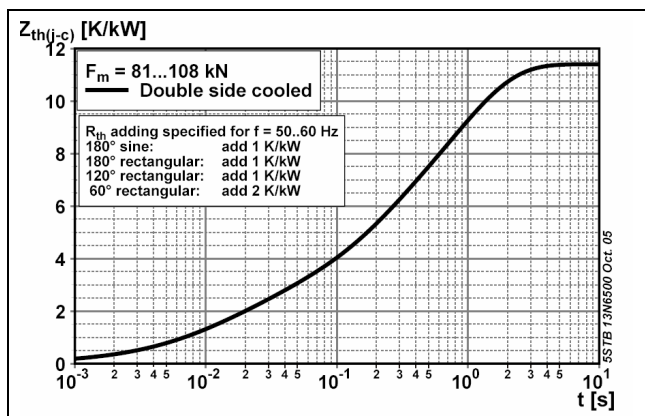


Fig. 1 Transient thermal impedance junction-to case

On-state characteristic model:

$$V_{T\max} = A + B \cdot I_T + C \cdot \ln(I_T + 1) + D \cdot \sqrt{I_T}$$

Valid for $i_T = 200 - 2000$ A

A	B	C	D
1.328	257.0×10^{-6}	-92.0×10^{-3}	28.0×10^{-3}

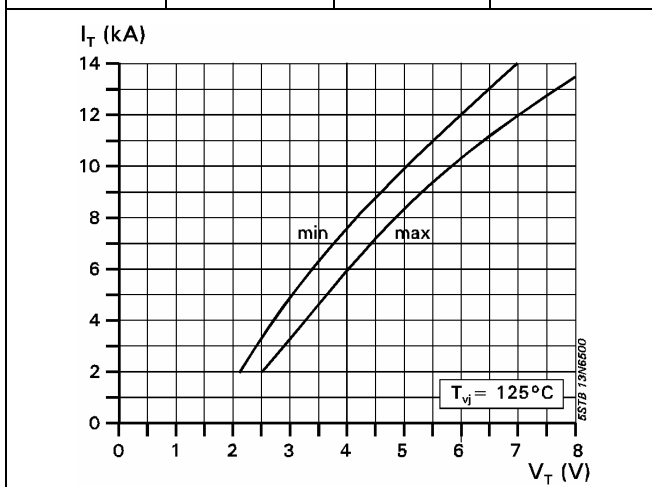


Fig. 2 On-state characteristics,
 $T_j = 125^\circ\text{C}$, 10ms half sine

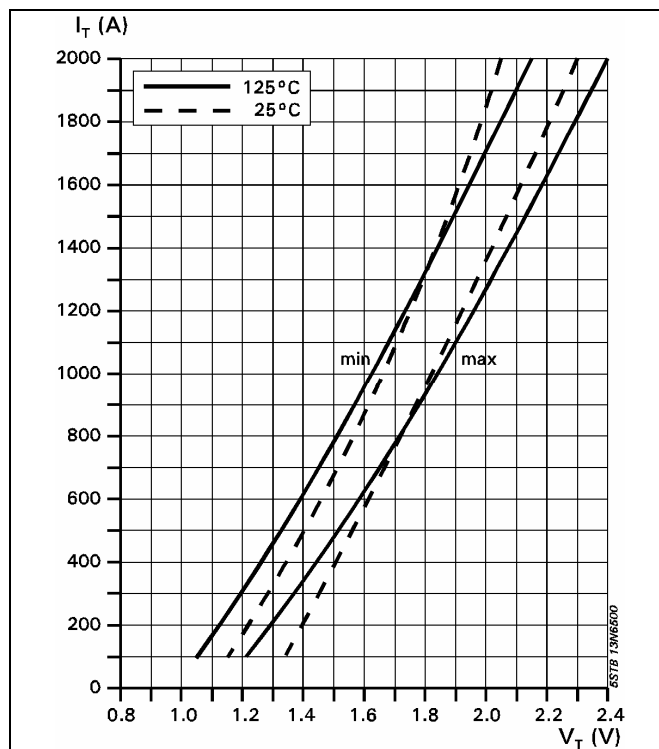


Fig. 3 On-state voltage characteristics

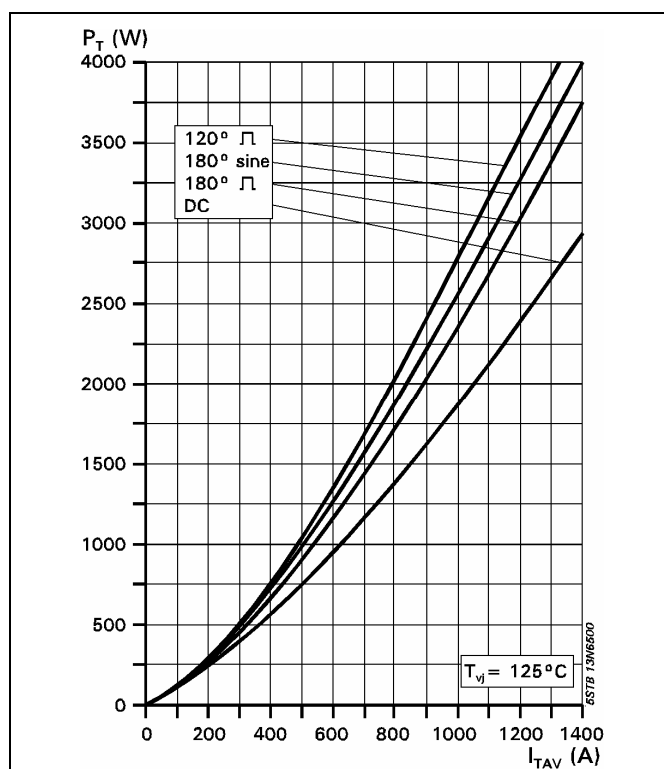


Fig. 4 On-state power dissipation vs. mean on-state current. Switching losses excluded.

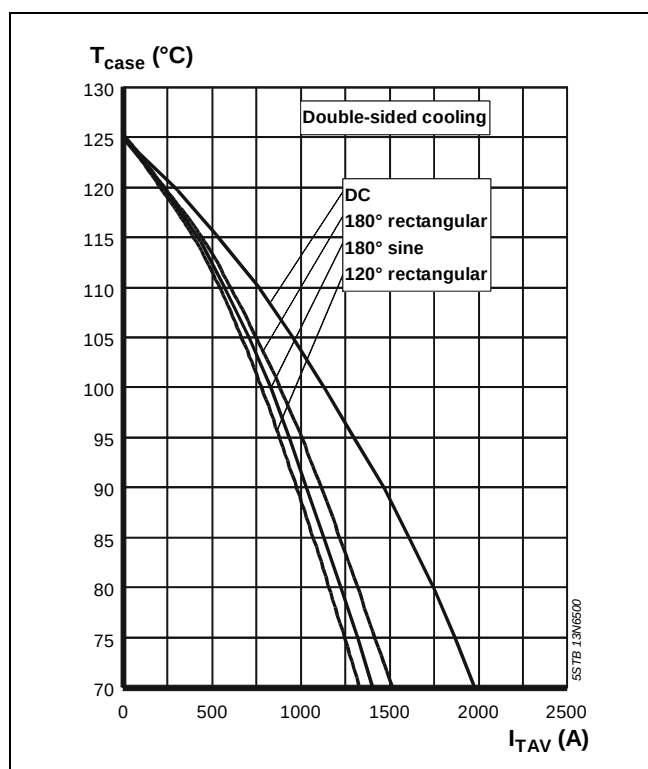


Fig. 5 Max. permissible case temperature vs. mean on-state current. Switching losses ignored.

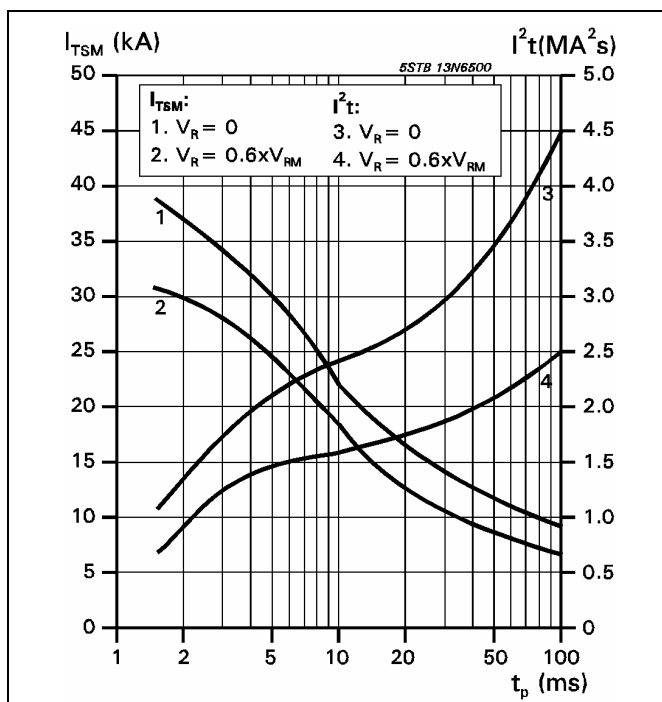


Fig. 6 Surge on-state current vs. pulse length.
Half-sine wave.

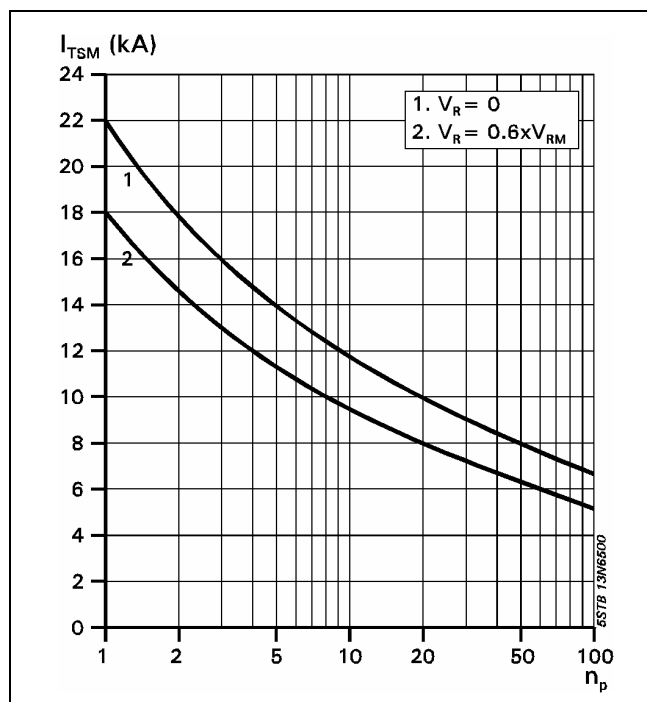


Fig. 7 Surge on-state current vs. number of pulses.
Half-sine wave, 10 ms, 50Hz.

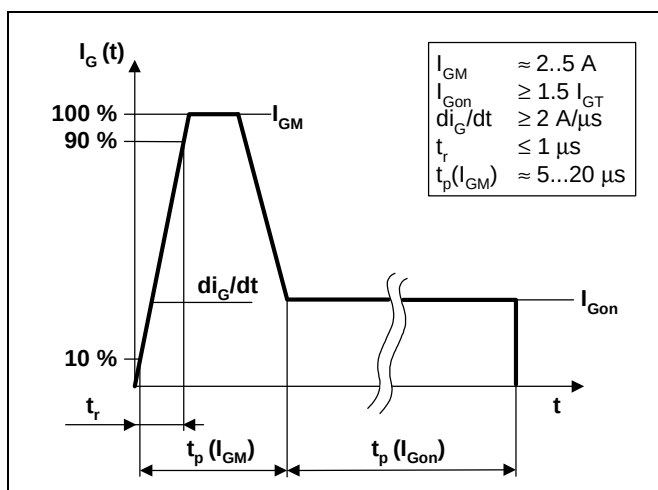


Fig. 8 Recommended gate current waveform

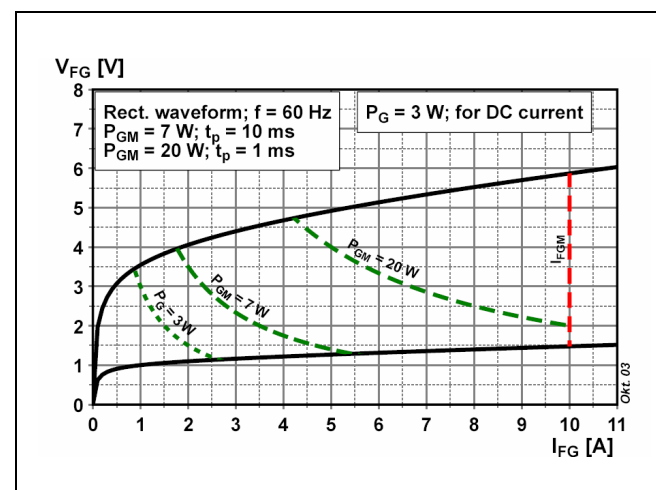


Fig. 9 Max. peak gate power loss

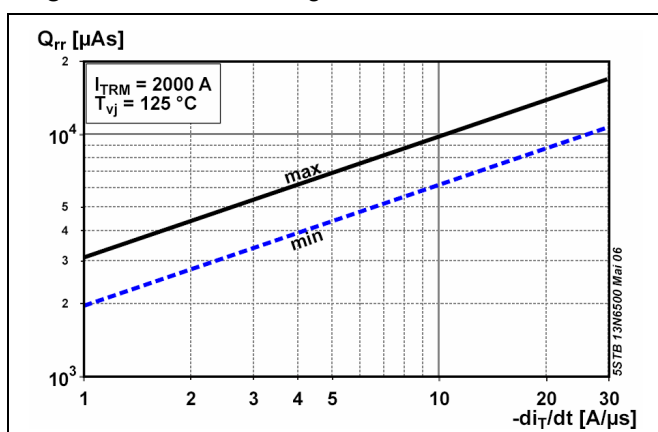


Fig. 10 Recovery charge vs. decay rate of on-state
current

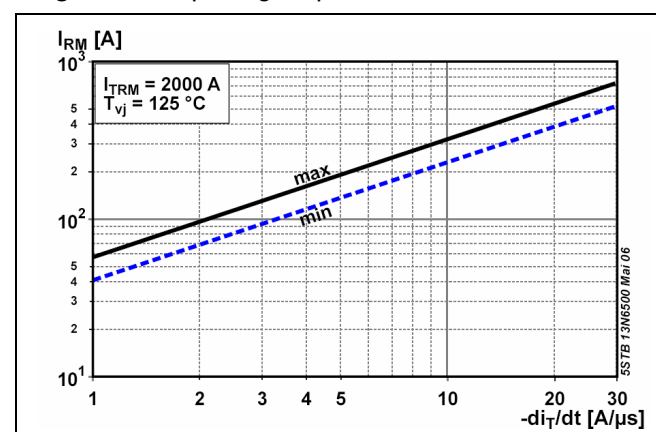


Fig. 11 Peak reverse recovery current vs. decay rate
of on-state current

Turn-on and Turn-off losses

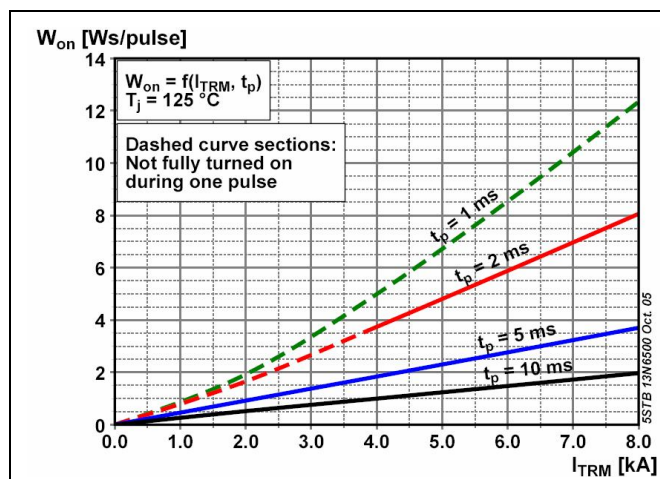


Fig. 12 Turn-on energy, half sinusoidal waves

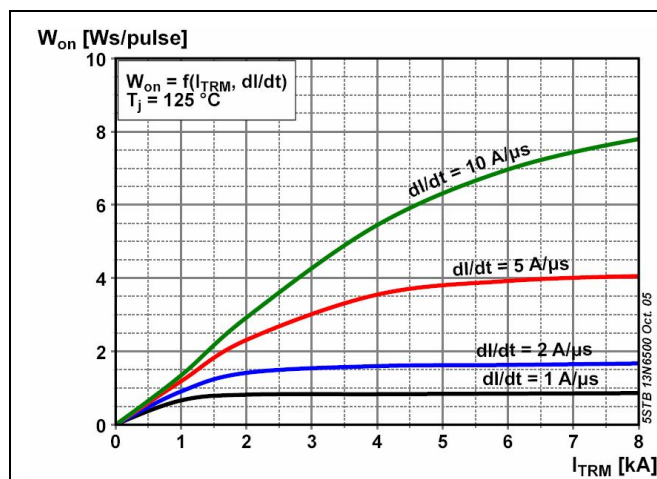


Fig. 13 Turn-on energy, rectangular waves

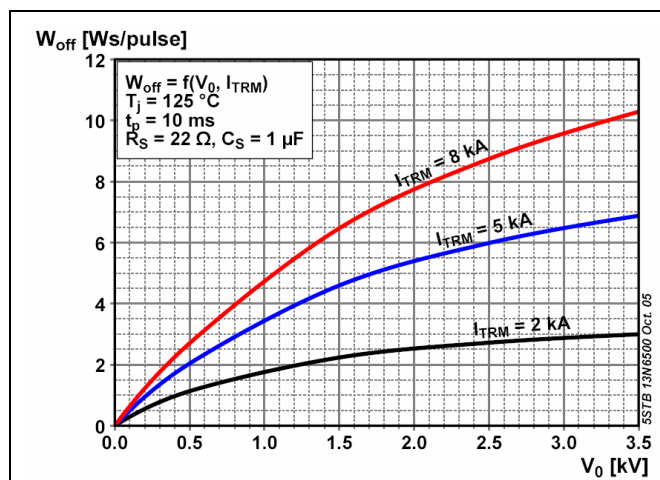


Fig. 14 Turn-off energy, half sinusoidal waves

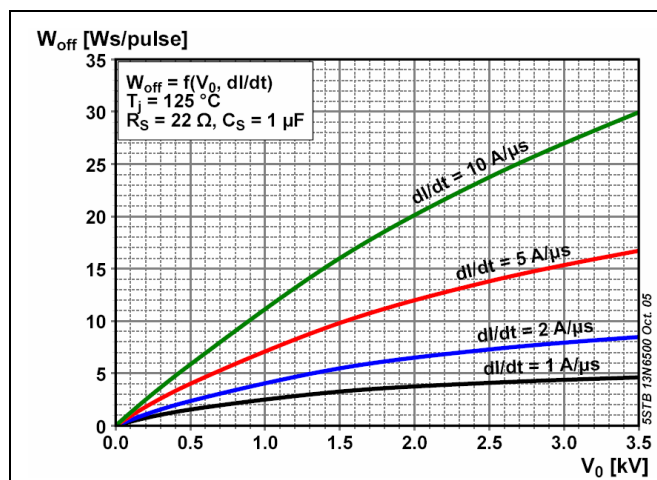


Fig. 15 Turn-off energy, rectangular waves

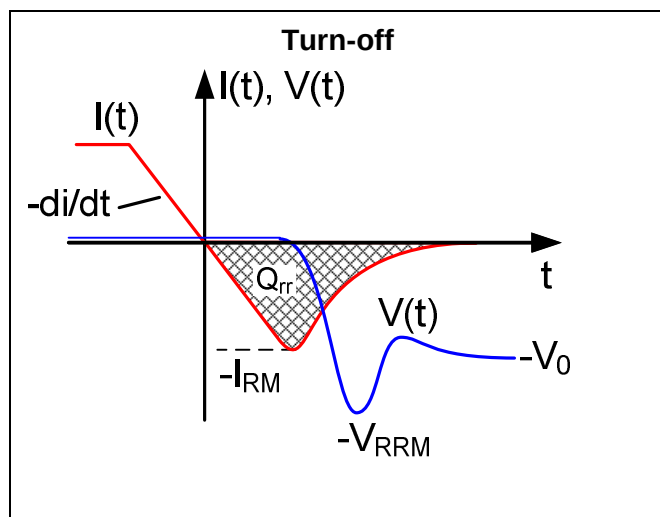


Fig. 16 Current and voltage waveforms at turn-off

Total power loss for repetitive waveforms:

$$P_{TOT} = P_T + W_{on} \cdot f + W_{off} \cdot f$$

where

$$P_T = \frac{1}{T} \int_0^T I_T \cdot V_T(I_T) dt$$

Fig. 17 Relationships for power loss

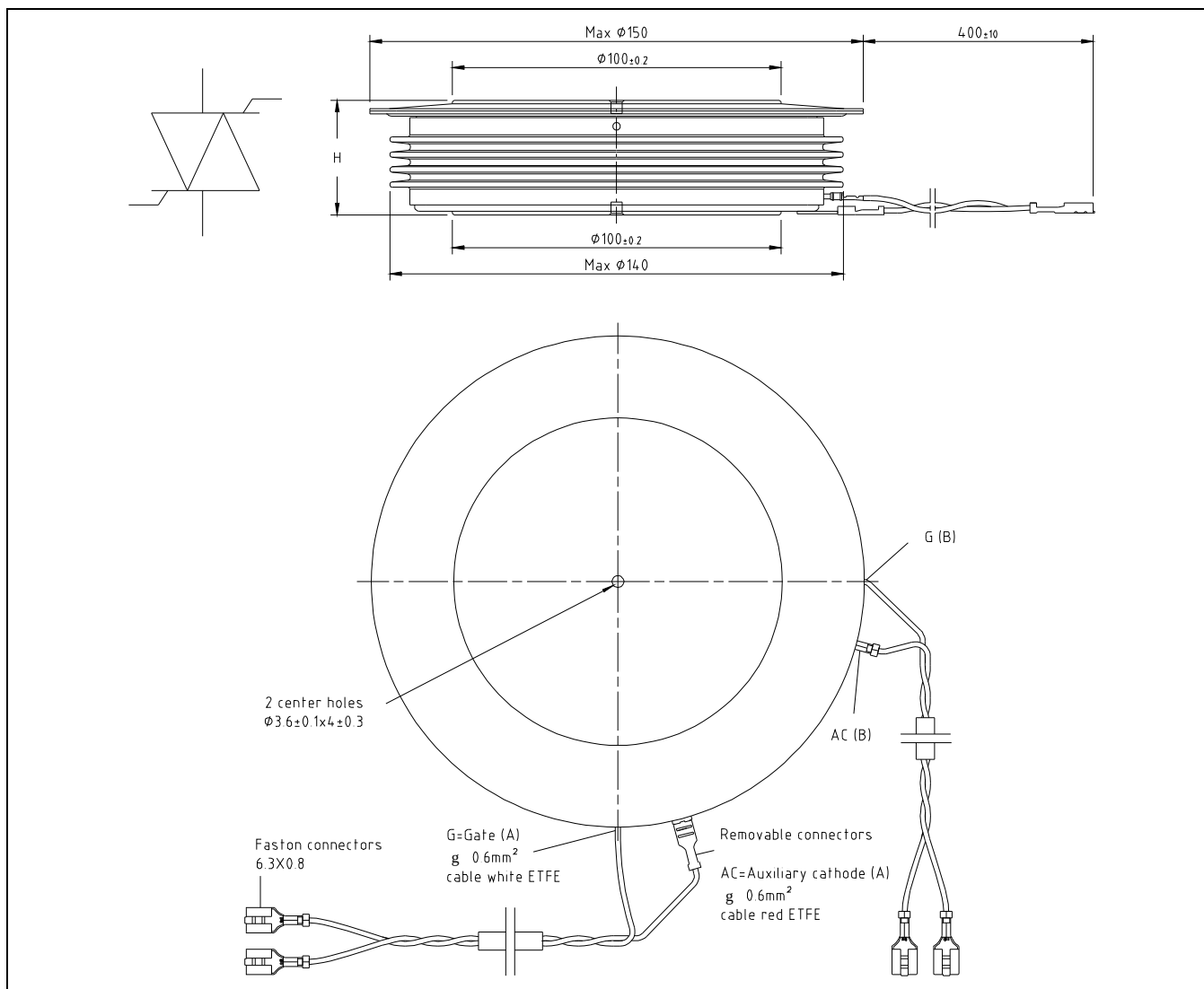


Fig. 18 Device Outline Drawing

Related documents:

5SYA 2020	Design of RC-Snubber for Phase Control Applications
5SYA 2034	Gate-Drive Recommendations for PCT's
5SYA 2036	Recommendations regarding mechanical clamping of Press Pack High Power Semiconductors
5SZK 9104	Specification of environmental class for pressure contact diodes, PCTs and GTO, STORAGE available on request, please contact factory
5SZK 9105	Specification of environmental class for pressure contact diodes, PCTs and GTO, TRANSPORTATION available on request, please contact factory

Please refer to <http://www.abb.com/semiconductors> for actual versions.

ABB Switzerland Ltd, Semiconductors reserves the right to change specifications without notice.



ABB Switzerland Ltd
Semiconductors
 Fabrikstrasse 3
 CH-5600 Lenzburg, Switzerland

Doc. No. 5SYA1035-03 May 06

Telephone +41 (0)58 586 1419
 Fax +41 (0)58 586 1306
 Email abbsem@ch.abb.com
 Internet www.abb.com/semiconductors

This datasheet has been downloaded from:

www.EEworld.com.cn

Free Download

Daily Updated Database

100% Free Datasheet Search Site

100% Free IC Replacement Search Site

Convenient Electronic Dictionary

Fast Search System

www.EEworld.com.cn